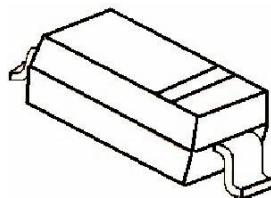


SOD-123

Marking: S8

特征 Features

- ⌘ 大电流承受能力。High Current Capability
- ⌘ 正向压降低。Low Forward Voltage Drop

机械数据 Mechanical Data

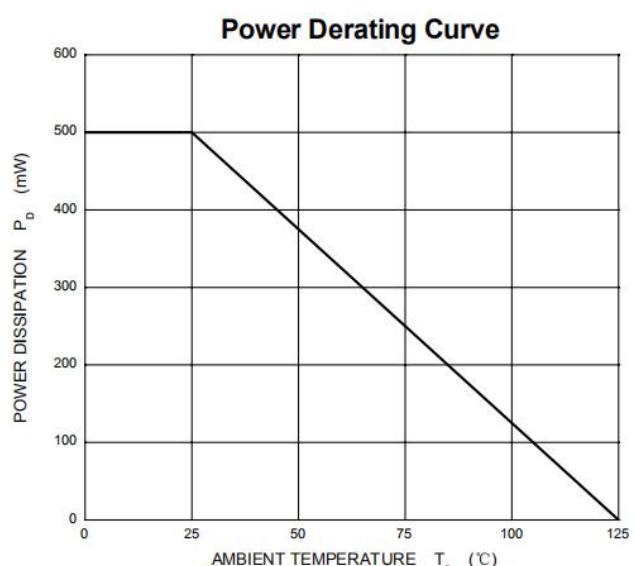
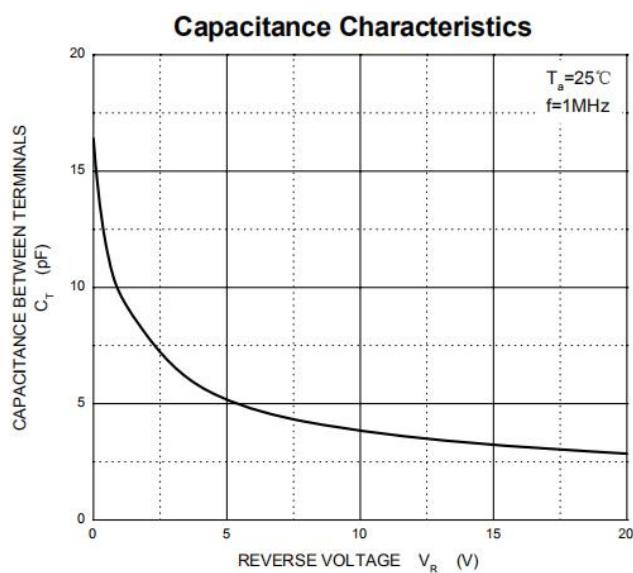
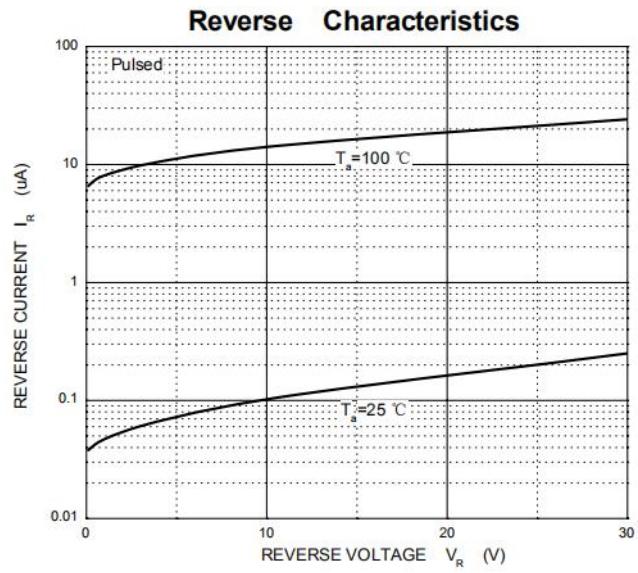
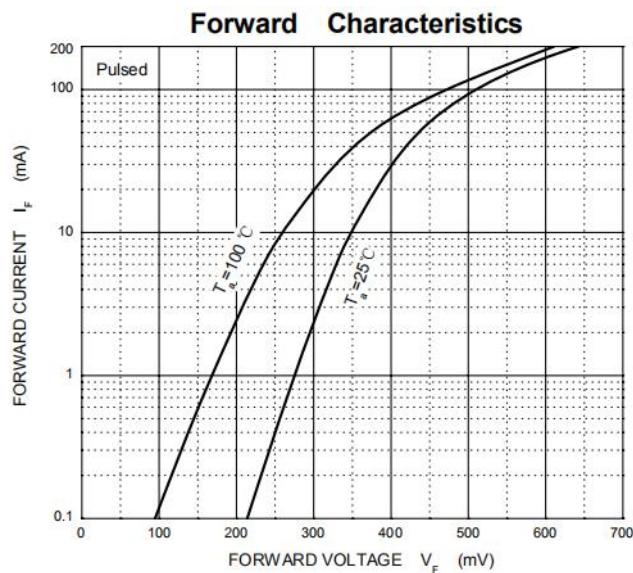
- ⌘ 封装: SOD-123 封装 SOD-123 Small Outline Plastic Package
- ⌘ 极性:色环端为负极 Polarity: Color band denotes cathode end
- ⌘ 环氧树脂 UL 易燃等级 Epoxy UL: 94V-0
- ⌘ 安装位置: 任意 Mounting Position: Any

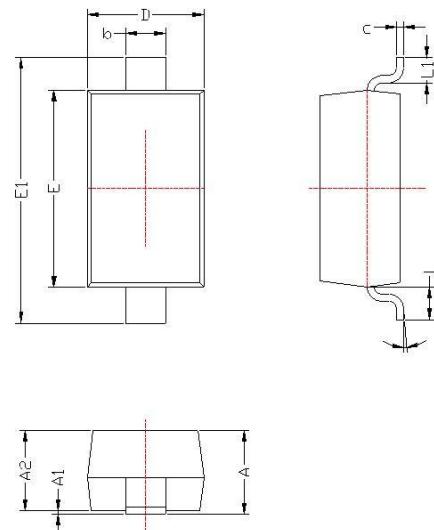
极限值和温度特性(TA = 25°C 除非另有规定)
Maximum Ratings & Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	BAT43W-E3-08-CN		单位 Unit
最大可重复峰值反向电压 Maximum repetitive peak reverse voltage	V _{RRM}	30		V
最大均方根电压 Maximum RMS voltage	V _{RMS}	21		V
最大直流阻断电压 Maximum DC blocking voltage	V _{DC}	30		V
最大正向平均整流电流 Maximum average forward rectified current	I _{FM}	200		mA
峰值重复正向电流 Repetitive Peak Forward Current @t<1.0s	I _{FRM}	500		mA
峰值正向浪涌电流 8.3ms 单一正弦半波 Peak forward surge current 8.3 ms single half sine-wave	I _{FSM}	4.0		A
典型热阻 Typical thermal resistance	R _{θJA}	200		°C/W
功率消耗 Power Dissipation	P _D	500		mW
结温 Junction Temperature	T _j	125		°C
存储温度 Storage temperature range	T _{STG}	-50-+150		°C

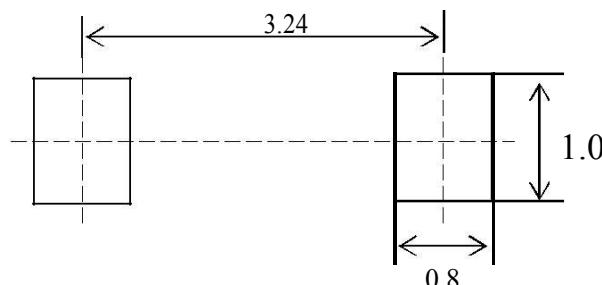
电特性 (TA = 25°C 除非另有规定)
Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified).

参数 Parameters	符号 Symbol	测试条件 Test conditions	Min	Typ	Max	单位 Unit
最大正向电压 Maximum forward voltage	V _F	I _F = 200mA			1.0	V
	V _F	I _F = 2.0mA	0.26		0.33	
	V _F	I _F = 15mA			0.45	
最大反向电压 Maximum reverse breakdown voltage	V _R	I _R =10uA	30			V
最大反向电流 Maximum reverse current	I _R	V _R =25V			0.5	uA
典型结电容 Type junction capacitance	C _j	V _R = 1.0V, f = 1MHz			10	pF
反向恢复时间 Reverse recovery time	t _{rr}	I _F =I _R =10mA I _{rr} =0.1xI _R , R _L =100 Ω			5	nS

Typical Characteristics


SOD-123 PACKAGE OUTLINE Plastic surface mounted package


SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.450	0.650
c	0.080	0.150
D	1.500	1.700
E	2.600	2.800
E1	3.550	3.850
L	0.500REF	
L1	0.250	0.450
θ	0°	8°

焊盘设计参考 Precautions: PCB Design(Recommended land dimensions for SOD-123 diode. Electrode patterns for PCBs)


技术要求:
 中心距: 3.24
 1, 塑封体尺寸: 2.70 X 1.60
 脚 宽: 0.55
 2: 未注公差为: ±0.05
 焊盘宽: 1.00
 脚 长: 0.50
 焊盘长: 0.80
 3, 所有单位: mm



无边界
ChipNobo

ChipNobo Co., Ltd

BAT43W-E3-08-CN

SOD-123 Plastic-Encapsulate
Schottky Barrier Diode

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